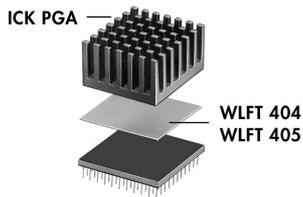


Data sheet Product ICK PGA 19 x 19 x 12

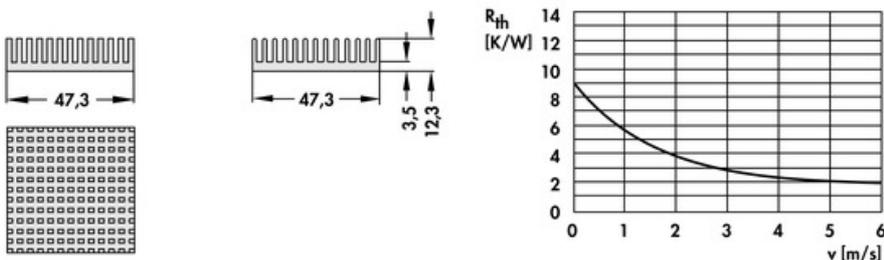


Heatsinks and active heatsinks for processors > Heatsinks for PGA
 47.3 x 47.3 x 12.3 mm, for IC design PGA and others

Features

way of fixation:	<ul style="list-style-type: none"> • therm. conductive foil • therm. cond. adhesive
socket:	universal
suitable for processor type:	universal
width:	47.3 mm
height:	12.3 mm
plate thickness:	3.5 mm
length:	47.3 mm
thermal resistance:	9 - 1.9 K/W
dissipation loss:	6.9 W
surface:	black anodised

Technical Drawing



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